

C0805X279D2TACTU

Aliases (C0805X279D2TAC7800)

SMD Comm X8G HT150C Flex, Ceramic, 2.7 pF, +/-0.5 pF, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.6 mm



| General Information | |
|--------------------------|--|
| Series | SMD Comm X8G HT150C Flex |
| Style | SMD Chip |
| Description | SMD, MLCC, High Temperature, Ultra-Stable |
| Features | High Temperature, Ultra-Stable |
| RoHS | Yes |
| Termination | Flexible Termination |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 11 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Dimensions | |
|------------|------------------|
| Chip Size | 0805 |
| L | 2mm +/-0.3mm |
| W | 1.25mm +/-0.3mm |
| Т | 0.78mm +/-0.20mm |
| S | 0.6mm MIN |
| В | 0.5mm +/-0.25mm |
| | |

| S | 0.6mm MIN |
|--------------------------|--------------------------|
| В | 0.5mm +/-0.25mm |
| | |
| Packaging Specifications | |
| Packaging | T&R, 180mm, Plastic Tape |

4000

Packaging Quantity

| Specifications | |
|--|--|
| Capacitance | 2.7 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | +/-0.5 pF |
| Voltage DC | 200 VDC |
| Dielectric Withstanding Voltage | 500 VDC |
| Temperature Range | -55/+150°C |
| Temp. Coefficient | X8G |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

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